

CMN3416ZM

20V, 14.6mΩ typ., 6.5A N-Channel MOSFET

General Description

The CMN3416ZM uses advanced trench technology to provide excellent RDS(ON) and low gate charge. This device is suitable for use as a load switch or in PWM applications. It is ESD protected.

Features

- ESD protected
- SOT-23-3L Package
- RoHS Compliant

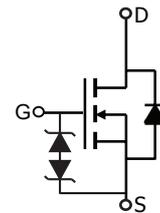
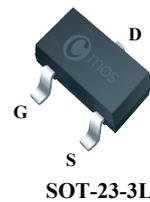
Product Summary

| BVDSS | RDS(on) max. | ID |
|-------|--------------|------|
| 20V | 18mΩ | 6.5A |

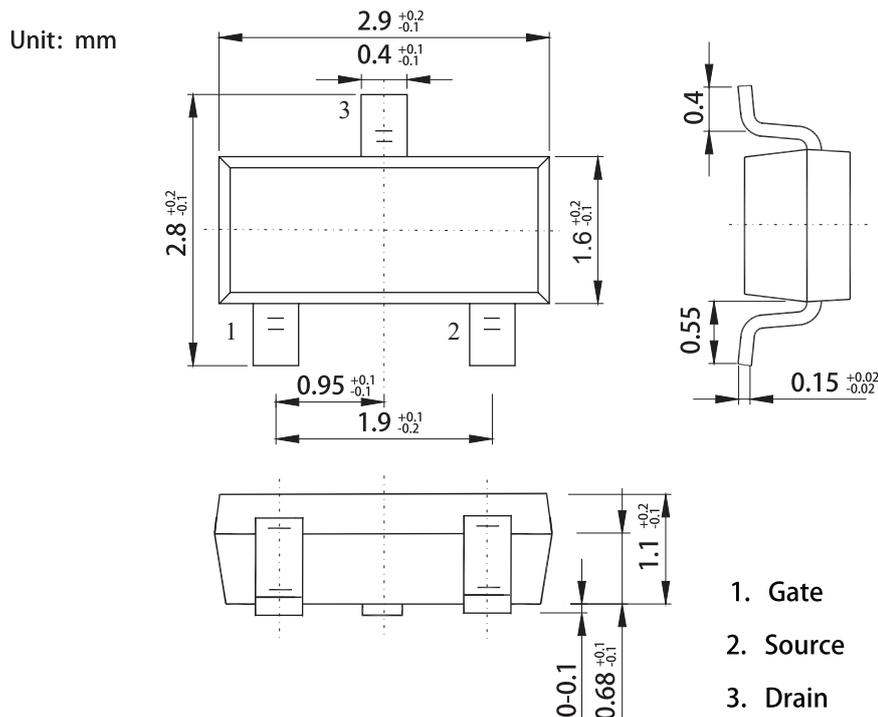
Applications

- PWM applications
- Load Switch
- Power Management
- PA Switch

SOT-23-3L Pin Configuration



| Type | Package | Marking |
|-----------|-----------|---------|
| CMN3416ZM | SOT-23-3L | 3416ZM |



Absolute Maximum Ratings

| Symbol | Parameter | Rating | Units |
|------------------------|--------------------------------------|------------|-------|
| V_{DS} | Drain-Source Voltage | 20 | V |
| V_{GS} | Gate-Source Voltage | ±8 | V |
| $I_D@T_A=25^{\circ}C$ | Continuous Drain Current | 6.5 | A |
| $I_D@T_A=70^{\circ}C$ | Continuous Drain Current | 5 | A |
| I_{DM} | Pulsed Drain Current | 30 | A |
| $P_D @T_A=25^{\circ}C$ | Total Power Dissipation | 1.4 | W |
| T_{STG} | Storage Temperature Range | -55 to 150 | °C |
| T_J | Operating Junction Temperature Range | -55 to 150 | °C |

Thermal Data

| Symbol | Parameter | Typ. | Max. | Unit |
|-----------------|---|------|------|------|
| $R_{\theta JA}$ | Thermal Resistance Junction-ambient($t_s \leq 10s$) | --- | 90 | °C/W |

Electrical Characteristics ($T_a=25^{\circ}C$, unless otherwise noted)

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|--------------|-----------------------------------|---|------|------|------|------|
| BV_{DSS} | Drain-Source Breakdown Voltage | $V_{GS}=0V, I_D=250\mu A$ | 20 | --- | --- | V |
| $R_{DS(ON)}$ | Static Drain-Source On-Resistance | $V_{GS}=4.5V, I_D=6.5A$ | --- | 14.6 | 18 | mΩ |
| | | $V_{GS}=2.5V, I_D=5.5A$ | --- | 18.2 | 25 | |
| $V_{GS(th)}$ | Gate Threshold Voltage | $V_{GS}=V_{DS}, I_D=250\mu A$ | 0.4 | --- | 1.1 | V |
| I_{DSS} | Drain-Source Leakage Current | $V_{DS}=16V, V_{GS}=0V$ | --- | --- | 1 | μA |
| I_{GSS} | Gate-Source Leakage Current | $V_{GS}=\pm 8V, V_{DS}=0V$ | --- | --- | ±10 | μA |
| g_{fs} | Forward Transconductance | $V_{DS}=5V, I_D=3A$ | --- | 10 | --- | S |
| R_g | Gate Resistance | $V_{DS}=0V, V_{GS}=0V, f=1MHz$ | --- | 1.4 | --- | kΩ |
| Q_g | Total Gate Charge | $I_D=6.5A$ | --- | 9 | --- | nC |
| Q_{gs} | Gate-Source Charge | $V_{DS}=10V$ | --- | 1.5 | --- | |
| Q_{gd} | Gate-Drain Charge | $V_{GS}=4.5V$ | --- | 3 | --- | |
| $T_{d(on)}$ | Turn-On Delay Time | $V_{DD}=10V$ $R_L=1.5\Omega$ $R_G=3\Omega$ $V_{GS}=5V$ | --- | 250 | --- | ns |
| T_r | Rise Time | | --- | 420 | --- | |
| $T_{d(off)}$ | Turn-Off Delay Time | | --- | 3950 | --- | |
| T_f | Fall Time | | --- | 3700 | --- | |
| C_{iss} | Input Capacitance | $V_{DS}=10V, V_{GS}=0V, f=1MHz$ | --- | 110 | --- | pF |
| C_{oss} | Output Capacitance | | --- | 100 | --- | |
| C_{rss} | Reverse Transfer Capacitance | | --- | 60 | --- | |

Diode Characteristics

| Symbol | Parameter | Conditions | Min. | Typ. | Max. | Unit |
|----------|-----------------------|---------------------|------|------|------|------|
| V_{SD} | Diode Forward Voltage | $V_{GS}=0V, I_S=1A$ | --- | 0.75 | 1.2 | V |

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Typical Characteristics

